

2.0A SBR[®] Surface Mount Super Barrier Rectifier *PowerDI*™123

Features

- Low Forward Voltage Drop
- Low Leakage Current
- Superior Reverse Avalanche Capability
- Excellent High Temperature Stability
- Patented Interlocking Clip Design for High Surge Current Capacity
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- ±16KV ESD Protection (HBM, 3B)
- ±25KV ESD Protection (IEC61000-4-2 Level 4, Air Discharge)
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q 101 Standards for High Reliability

Maximum Ratings @ TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage	V _{RRM}			
Working Peak Reverse Voltage	V _{RWM}	40	V	
DC Blocking Voltage	V _{RM}			
RMS Reverse Voltage	V _{R(RMS)}	28	V	
Average Rectified Output Current (See Figure 1)	lo	2.0	A	
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	50	A	
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 2) Thermal Resistance Junction to Ambient (Note 3) Thermal Resistance Junction to Ambient (Note 4)	R _{ejs} R _{eja} R _{eja}	5 180 115	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C	

Notes: 1. RoHS revision 13.2.2003. High temperature solder exemption applied, see EU Directive Annex Note 7.

2. Theoretical R_{eus} calculated from the top center of the die straight down to the PCB cathode tab solder junction.

3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.

4. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.

SBR is a registered trademark of Diodes Incorporated. PowerDI is a trademark of Diodes Incorporated.

- Mechanical Data
 - Case: PowerDI™123
 - Case Material: Molded Plastic, "Green" Molding compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Polarity Indicator: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 ⁽²⁾
- Marking Information: See Page 4
- Ordering Information: See Page 4

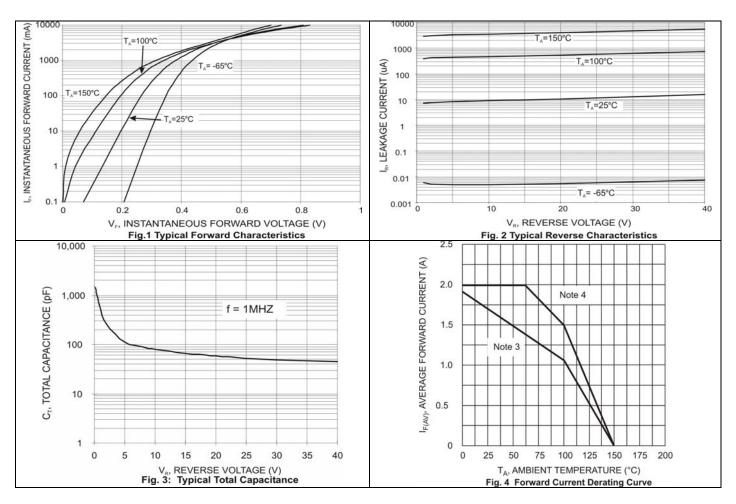


Electrical Characteristics @ T_A = 25°C unless otherwise specified Characteristic Symbol Min Max Unit **Test Condition** Тур V Reverse Breakdown Voltage (Note 5) V_{(BR)R} 40 I_R = 100 μA _ 0.265 0.315 _ $I_F = 0.1A, T_J = 25^{\circ}C$ 0.38 0.43 I_F = 1.0A,T_J = 25°C 0.45 0.50 $I_F = 2.0A, T_J = 25^{\circ}C$ Forward Voltage Drop V_{F} V 0.17 0.22 $I_F = 0.1A, T_J = 125^{\circ}C$ I_F = 1.0A,T_J = 125°C 0.325 0.375 I_F = 2.0A,T_J = 125°C 0.42 0.47 _ 8 40 μA V_R = 5V, T_J = 25 °C 16 100 μA V_R = 40V, T_J = 25 °C Leakage Current (Note 5) I_R V_R = 5V, T_J = 125 °C 1.3 8 mΑ V_R = 40V, T_J = 125 °C 10 2.1 mΑ

Notes:

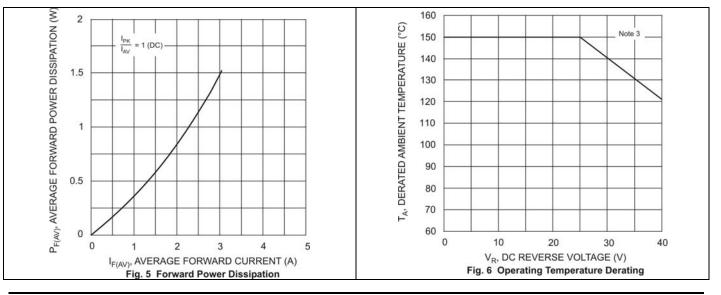
NEW PRODUCT

5. Short duration pulse test used to minimize self-heating effect.

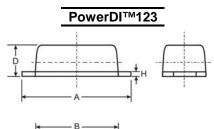




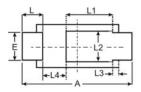




Package Outline Drawings







PowerDI [™] 123								
Dim	Min	Max	Тур					
Α	3.65	3.75	3.70					
в	2.775	2.825	2.80					
С	1.750	1.800	1.775					
D	0.955	1.000	0.98					
Е	0.95	1.05	1.00					
н	0.15	0.25	0.20					
L	0.60	0.70	0.65					
L1	_	_	1.36					
L2	—	_	1.10					
L3		_	0.20					
L4	L4 0.95		1.05					
All Dimensions in mm								



Marking, Polarity, Weight & Ordering Information

2	Case	Style	Marking	Weight		
SBR2A40F	Top View Back View		[]2A4 ⋛]	0.096g (approx.)		

Ordering Information	Date Code				
SBR2A40P1-7 3000/Tape & Reel	2A4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)				

Date Code Key

Year	2006		2007		2008		2009		2010	2	2011	20)12
Code	Т		U		V		W	W X		Y		Z	
N	lonth	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
(Code	1	2	3	4	5	6	7	8	9	0	Ν	D

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